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Part Number:

87832-5422

Status:

Active

Overview:

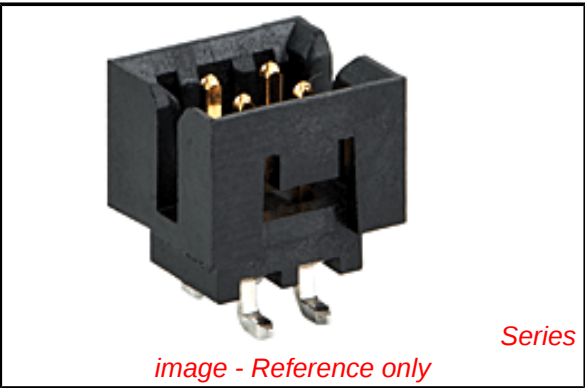
Milli-Grid™ Connector System

Description:

Milli-Grid™ Header, Surface Mount, Vertical, Shrouded, Lead-Free, 10 Circuits, 0.38µm Gold (Au) Plating, with Pick-and-Place Cap, without Side Locking Window, with Center Locking Window, with Centre Polarization Slot, with PC

Documents:	
3D Model	Product Specification PS-87831-027 (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification	
CSA	LR19980
UL	E29179
General	
Product Family	PCB Headers
Series	87832
Application	Signal, Wire-to-Board
Comments	With Cap Contact Molex for application in automotive industry
Overview	Milli-Grid™ Connector System
Product Name	Milli-Grid™
UPC	822348271443
Physical	
Breakaway	No
Circuits (Loaded)	10
Circuits (maximum)	10
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Compliant	No
Guide to Mating Part	No
Keying to Mating Part	Yes
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Net Weight	0.476/g
Number of Rows	2
Orientation	Vertical
PCB Locator	No
PCB Retention	None
Packaging Type	Embossed Tape on Reel
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to PCB	No
Robotic Placement	Pick and Place Cap
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	Yes



EU RoHS

ELV and RoHS Compliant

REACH SVHC

Contains SVHC: No

Low-Halogen Status

Not Low-Halogen

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

87832Series

Mates With

50394 Wire-to-Board Terminals, 51110 Wire-to-Board Crimp Housing, 87568 Wire-to-Board IDT Housings, 79107 Board-to-Board Top Entry Through Hole Receptacle, 79108 Board-to-Board FFC/FPC Top Entry Through Hole Receptacle, 79109 Board-to-Board Surface Mount PCB Receptacle

Temperature Range - Operating

Termination Interface: Style

-55°C to +105°C

Surface Mount

Electrical

Current - Maximum per Contact

Voltage - Maximum

2A

125V

Solder Process Data

Duration at Max. Process Temperature (seconds)

Lead-free Process Capability

Max. Cycles at Max. Process Temperature

Process Temperature max. C

10

Reflow Capable (SMT only)

1

260

Material Info

Reference - Drawing Numbers

Product Specification

Sales Drawing

PS-87831-027

SD-87832-006

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